## **Radial Ceramic Capacitors**



## **Features**

Radial leaded technology

**Excellent solderability** 

Ideal for industrial and commercial applications

## **Part Number Description**

## RND 150 [M] [NPO] [010] [C] [2A] [R15DS7] [16] [A]

Series [1] [2] [3] [4] [5] [6] [7] [8]

## [1] Type

Symbol	Туре
М	Radial

## [2] Temperature Characteristic

Temp.	Temperature	Capacitance
Charact.	Range	Change
NPO	-55 ~ <b>125</b> °C	0±30 ppm/°C

## [3] Capacitance Value

Symbol	Capacitance
Зуппоп	Value
060	6pF
6R8	6.8pF
120	12pF
471	470pF
222	2200pF
104	100000pF

## [4] Capacitance Tolerance

Cumbal	Capacitance
Symbol	Tolerance
С	±0.25pF
J	±5%

## [5] Rated Voltage

Symbol	Rated Voltage
2A	DC 100V
2H	DC 500V

#### [6] Style

Symbol	Dimension (unit:mm)					
Symbol	W(max)	L(max)	T(max)	F(±0.8)	Фd	
R15AS2	4.5	4.8	3	2.5	0.52	
R15DS7	4.5	4.8	3	5	±0.05	

## [7] Lead Length (L)

(mm)

Packing	Bulk			Tapir	ng(H)	
Symbol	04	06	10	25	16	20
Length	3.5	6	10	25	16	20
Tol.	±0.5	±1	±1	±3	+1.5 -1	+1.5 -1

## [8] Packaging

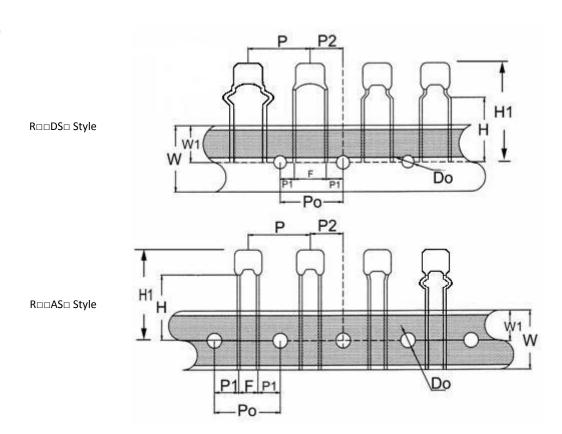
Symbol	Packing
Blank	Bulk
Α	AMMO



## **Dipped Radial Lead Type**

Taping

(Refer to [6] Style)



Unit:mm

				O'IIICIIIIII
Description		R□□AS□	R□□DS□	Damani
		Style	Style	Remark
Carrier tape width	W	18±0.5		
Position of sprocket hole	W1	9±(	0.5	
Pitch of component	Р	12.7	Ref.	
Pitch of sprocket hole	Ро	12.7	±0.3	
Length from hole center to Lead	P1	5.1±0.7	3.85±0.7	
Length from hole center to component center	P2	6.35	Ref.	
Diameter of sprocket hole	Do	4±(	0.3	
Lead crimp height	Н	18 <sup>+1.5</sup> <sub>-1</sub>	16 <sup>+1.5</sup> <sub>-1</sub>	
Lead spacing	F	2.5±0.8	5±0.8	
Top of component height	H1	26.5Max		



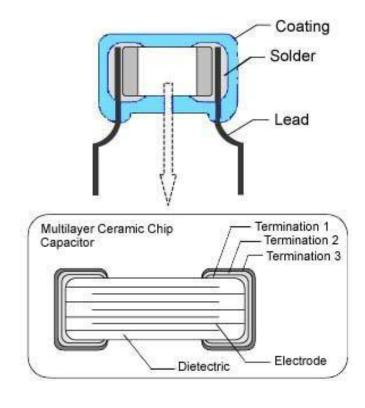
## **Electrical Characteristics**

NPO

Item	Temperature Compensating	Measuring Condition
Operating Temperature Range	-55 ~ +125°C	
Temperature Characteristics	0 ± 30 ppm/°C	
Capacitance	Within the specified tolerance	Shall be measured at $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$ at the frequency and voltage
Q	C≧30pF : Q≧1000 C < 30pF : Q≧400 + 20 × C (C is nominal capacitance)	C≦1000pF@1MHz $\pm$ 20%, $1\pm$ 0.2Vrms C > 1000pF@1KHz $\pm$ 10%, $1\pm$ 0.2Vrms
Withstanding Voltage	No defects	Applied voltage: Rated voltage ×2.5  100V~999V Rated voltage × 1.5  1000~3000V Rated voltage × 1.2  Duration: 1 to 5 sec.  The charge/discharge current is less than  50mA
Insulation Resistance	More than $10G\Omega$ or $500M\Omega\cdot\mu\text{F}$ , whichever is less $16\text{Vdc}$ product : More than $10G\Omega$ or $100M\Omega\cdot\mu\text{F}$ , whichever is less	Apply rated voltage for 1 minute at 25°C± 2°Cand 70%R.H. max.  16Vdc product:  Measurement voltage is 25Vdc



## **Material List**



## Storage

1. The storage conditions should be:

Temperature = Lower than  $40^{\circ}$ C Humidity = Lower than 70% R.H.

2. After opening the package, please store in desiccators.

## **Environmental and Test Characteristics**

Item	Temperature Compensating	Measuring Condition
Strength of termination	Termination not to be broken or loosened $\label{eq:Force:2LBmin.}$ Force: 2 LB min. $\label{eq:Keep time:10\pm1 sec.}$	F,
Solderability of leads	Lead wire to be soldered vertically up to the coating end point.  At least 75% of lead surface is covered	Solder temperature : $260 \pm 5^{\circ}\text{C}$ Dipping : $2 \pm 0.5$ sec. (Flux shall be used)



## **Environmental and Test Characteristics**

NPO

ltem	Temperature Compensating	Measuring Condition				
Resistance to Soldering hea	t					
ΔC	$\pm$ 2.5% or $\pm$ 0.25pF (Whichever is greater)					
Q	$\begin{split} \text{C} & \geqq 30 \text{pF} : \text{Q} & \geqq 1000 \\ \text{C} & \leqslant 30 \text{pF} : \text{Q} & \leqq 400 + 20 \times \text{C} \\ \text{(C is nominal capacitance)} \\ \text{More than } 10 \text{G}\Omega \text{ or } 500 \text{M}\Omega  \bullet \mu \text{ F} \text{ ,} \end{split}$	The lead wire is immersed in the melted solder 1.5mm to 2mm from the main body at 260 $\pm$ 5 $^{\circ}$ C for 10 $\pm$ 0.5sec.				
I.R.	whichever is less. $16Vdc \ product : \\ More \ than \ 10G\Omega \ or \ 100M\Omega \ \bullet \mu \ F  , \\ whichever \ is \ less.$	Let sit at room temperature for 24 $\pm$ 2 hrs. then measure.				
Withstanding voltage	No defects	Perform the initial measurement.				
Exterior	No abnormalities					
Thermal shock						
ΔC	$\pm$ 2.5% or $\pm$ 0.25pF (Whichever is greater)	Fix the capacitor to the supporting jig in the				
Q	$C \ge 30 pF : Q \ge 1000$ $C < 30 pF : Q \ge 400 + 20 \times C$ (C is nominal capacitance)	same manner and under the same conditions as (Resistance to Soldering heat ). Perform the five cycles according to the four heat treatments listed in the following table.				
I.R.	More than $10G\Omega$ or $500M\Omega$ • $\mu$ F , whichever is less. 16Vdc product :	Remove and let sit at room temperature for 24 $\pm$ 2 hrs., then measure.				
	More than $10G\Omega$ or $100M\Omega$ • $\mu$ F , whichever is less.	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				
Withstanding voltage	No defects	Time 3±30 15 3±30 15				
Exterior	No abnormalities	Perform the initial measurement.				



## **Environmental and Test Characteristics**

NPO

ltem	Temperature Compensating	Measuring Condition
Moisture resistance (Steady state)		
ΔC	$\pm$ 5% or $\pm$ 0.5pF (Whichever is greater)	
Q	$C \ge 30 pF : Q \ge 350$ $10 pF > C < 30 pF : Q \ge 275 + \frac{5}{2} \times C$ $C \le 10 pF : Q \ge 200 + 10 \times C$ (C is nominal capacitance)	Apply the rated DC voltage at $40 \pm 2^{\circ}$ C and 90 to 95% R.H. for $500^{+24}_{-0}$ hrs. Remove and let sit at room temperature for 24 $\pm$ 2 hrs., then measure. Perform the initial measurement.
I.R.	More than $1000$ M $\Omega$ or $50$ M $\Omega$ · $\mu$ F , whichever is less. $16$ Vdc product : More than $1000$ M $\Omega$ or $10$ M $\Omega$ · $\mu$ F , whichever is less.	
Withstanding voltage	No defects	
Exterior	No abnormalities	
High temperature loading		
ΔC	$\pm$ 3% or $\pm$ 0.3pF (Whichever is greater)	
Q	$C \ge 30 pF : Q \ge 350$ $10 pF > C < 30 pF : Q \ge 275 + \frac{5}{2} \times C$ $C \le 10 pF : Q \ge 200 + 10 \times C$	Apply 200% of the rated DC voltage for $1000^{+48}_{-0}$ hrs. at the maximum operating temperature $\pm$ 2°C. Remove and let sit at room temperature for 24 $\pm$ 2 hrs., then measure. The charge/discharge current is less than 50mA. Perform initial measurement.  • $100V \le V < 1000V$ : 150% of rated voltage.  • $V \le 1000V$ : 120% of rated
I.R.	More than $1000M\Omega$ or $50M\Omega$ • $\mu$ F , whichever is less. $16Vdc$ product : More than $1000M\Omega$ or $10M\Omega$ • $\mu$ F , whichever is less.	
Withstanding voltage	No defects	voltage (max.3600V)
Exterior	No abnormalities	